

Title (en)
ELECTRONIC DEVICE COMPRISING A PLURALITY OF ELECTRONIC COMPONENTS LAID DOWN ON A SUBSTRATE AND ASSOCIATED INFRARED SENSOR

Title (de)
ELEKTRONISCHE VORRICHTUNG MIT MEHREREN AUF EINEM SUBSTRAT ABGELEGTE KOMPONENTEN UND INFRAROTSENSOR DAFÜR

Title (fr)
DISPOSITIF ÉLECTRONIQUE COMPRENANT UNE PLURALITÉ DE COMPOSANTS ÉLECTRONIQUES RAPPORTÉS SUR UN SUBSTRAT ET CAPTEUR INFRAROUGE ASSOCIÉ

Publication
EP 2294616 A2 20110316 (FR)

Application
EP 09772671 A 20090706

Priority
• FR 2009000832 W 20090706
• FR 0803798 A 20080704

Abstract (en)
[origin: WO201000988A2] The present invention relates to a system of components to be hybridized, adapted to a technique of hybridization by weld bead fusion, of the type known by the designation "flip-chip" and its subject is more particularly on the one hand an electronic device comprising a plurality of electronic components (15) laid down on a substrate (11), each component consisting of a part of a layer (12) made of a mechanically active material, linked to the substrate (11) by way of an electrically conducting linking element (13) specific thereto, the layer of active material comprising at least one trench (14), characterized in that said at least one trench (14) delimits, at least in part, groups of electronic components each comprising at least two components and forming successive bands, two successive bands comprising a common border.

IPC 8 full level
H01L 27/146 (2006.01); **H01L 25/065** (2006.01)

CPC (source: EP US)
H01L 27/14649 (2013.01 - EP US); **H01L 27/14618** (2013.01 - EP US); **H01L 27/14634** (2013.01 - EP US); **H01L 27/14636** (2013.01 - EP US); **H01L 2224/73204** (2013.01 - EP US); **H01L 2924/0002** (2013.01 - US); **H01L 2924/351** (2013.01 - EP)

C-Set (source: US)
H01L 2924/0002 + H01L 2924/00

Citation (search report)
See references of WO 201000988A2

Designated contracting state (EPC)
AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO SE SI SK SM TR

Designated extension state (EPC)
AL BA RS

DOCDB simple family (publication)
WO 201000988 A2 20100107; WO 201000988 A3 20100415; EP 2294616 A2 20110316; FR 2933535 A1 20100108; FR 2933535 B1 20110318; US 2011198719 A1 20110818

DOCDB simple family (application)
FR 2009000832 W 20090706; EP 09772671 A 20090706; FR 0803798 A 20080704; US 99459709 A 20090706